DATA SHEET
CLL130-0101A5-30AM1B1

CITILED
The Light Engine

Ref.CE-P2157 09/12
1. Scope of Application
These data sheet are applied to the chip type LED lamp, model CLL130-0101A5-30AM1B1

2. Part code

CLL130-0101A5-30AM1B1

[1] Series
   CLL: LED for general lighting

[2] Outline dimensions
   130: 2.0(L) x 1.6(W) x 0.75(H)

[3] Dies in series quantity
   01: 1

[4] Dies in parallel quantity
   01: 1

[5] Correlated color temperature
   30: 3000K

[6] Chromaticity range
   A: ANSI C78.377-2008

[7] CRI
   M1: Ra Min 80 Type
3. Outline drawing

Unit : mm
Tolerance : ±0.1mm

4. Performance

(1) Absolute Maximum Rating

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Rating Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Power Dissipation</td>
<td>PD</td>
<td>292</td>
<td>mW</td>
</tr>
<tr>
<td>Forward Current</td>
<td>IF</td>
<td>85</td>
<td>mA</td>
</tr>
<tr>
<td>Forward Pulse Current</td>
<td>IFP</td>
<td>100</td>
<td>mA</td>
</tr>
<tr>
<td>Minimum current</td>
<td>IR min</td>
<td>5</td>
<td>mA</td>
</tr>
<tr>
<td>Reverse Current</td>
<td>IR</td>
<td>1</td>
<td>mA</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>TOP</td>
<td>-30 ~ +85</td>
<td>C</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>ST</td>
<td>-40 ~ +100</td>
<td>C</td>
</tr>
<tr>
<td>Junction Temperature</td>
<td>Tj Max</td>
<td>120</td>
<td>C</td>
</tr>
</tbody>
</table>

*1 Forward Current : Duty<=1/10 , Pulse Width<=10msec
*2 D.C. Current : Tj = Ts + Rj×s × PD

Pulse Current : Tj = Ts + Rj×s × Pw(Power Dissipation / One-Pulse) × Duty
*Ts : Solder terminal(Anode)temperature
(2) Electro-optical Characteristics

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>$V_F$</td>
<td>$I_F=50mA$</td>
<td>2.65</td>
<td>2.95</td>
<td>3.25</td>
<td>V</td>
</tr>
<tr>
<td>Thermal Resistance</td>
<td>$R_{j-s}^*$</td>
<td>Junction-solder</td>
<td>-</td>
<td>45</td>
<td>-</td>
<td>C/W</td>
</tr>
<tr>
<td>Luminous Flux</td>
<td>$\Phi_V$</td>
<td>$I_F=50mA$</td>
<td>13.8</td>
<td>17.3</td>
<td>20.8</td>
<td>lm</td>
</tr>
<tr>
<td>General Color Rendering Index</td>
<td>Ra</td>
<td>$I_F=50mA$</td>
<td>80</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
</tbody>
</table>

*1 Thermal Resistance : Junction - Solder terminal (Anode)

Ranking (Condition : $I_F=50mA$, $T_s=25C$)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Rank</th>
<th>Min.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>$V_F$</td>
<td>Q</td>
<td>2.65</td>
<td>2.85</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>R</td>
<td>2.85</td>
<td>3.05</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>S</td>
<td>3.05</td>
<td>3.25</td>
<td></td>
</tr>
<tr>
<td>Luminous Flux</td>
<td>$\Phi_V$</td>
<td>C</td>
<td>13.8</td>
<td>17.3</td>
<td>lm</td>
</tr>
<tr>
<td></td>
<td></td>
<td>D</td>
<td>17.3</td>
<td>20.8</td>
<td></td>
</tr>
</tbody>
</table>

Chromaticity coordinates (Condition : $I_F=50mA$, $T_s=25C$)

<table>
<thead>
<tr>
<th>Color Rank</th>
<th>$x$</th>
<th>$y$</th>
<th>Color Rank</th>
<th>$x$</th>
<th>$y$</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>0.4431</td>
<td>0.4213</td>
<td>2</td>
<td>0.4562</td>
<td>0.4260</td>
</tr>
<tr>
<td></td>
<td>0.4299</td>
<td>0.4165</td>
<td></td>
<td>0.4431</td>
<td>0.4213</td>
</tr>
<tr>
<td></td>
<td>0.4223</td>
<td>0.3990</td>
<td></td>
<td>0.4345</td>
<td>0.4033</td>
</tr>
<tr>
<td></td>
<td>0.4345</td>
<td>0.4033</td>
<td></td>
<td>0.4468</td>
<td>0.4077</td>
</tr>
<tr>
<td>3</td>
<td>0.4345</td>
<td>0.4033</td>
<td>4</td>
<td>0.4468</td>
<td>0.4077</td>
</tr>
<tr>
<td></td>
<td>0.4223</td>
<td>0.3990</td>
<td></td>
<td>0.4345</td>
<td>0.4033</td>
</tr>
<tr>
<td></td>
<td>0.4147</td>
<td>0.3814</td>
<td></td>
<td>0.4260</td>
<td>0.3854</td>
</tr>
<tr>
<td></td>
<td>0.4260</td>
<td>0.3854</td>
<td></td>
<td>0.4373</td>
<td>0.3893</td>
</tr>
</tbody>
</table>

*1 The tolerance of measurement at our tester is $V_F\pm3\%$, $\Phi_V\pm7\%$, Chromaticity($x$,$y$)$\pm0.01$

*For an order, products within the rank listed above will be delivered.

Except designation of a delivery proportion of each rank.
5. Characteristics

- Forward Current vs. Forward Voltage
  ![Graph](image1)

- Forward Current vs. Relative Luminous Intensity
  ![Graph](image2)

- Forward Current vs. Chromaticity Coordinate
  ![Graph](image3)

- Solder Temperature vs. Chromaticity Coordinate
  ![Graph](image4)

- Solder Temperature vs. Forward Voltage
  ![Graph](image5)

- Solder Temperature vs. Relative Luminous Intensity
  ![Graph](image6)
LED chip is mounted on White color PCB.
6. Reliability

(1) Details of the tests

<table>
<thead>
<tr>
<th>Test Item</th>
<th>Test Condition</th>
</tr>
</thead>
<tbody>
<tr>
<td>Continuous Operation Test</td>
<td>Ta=60°C, ( I_F=50) mA, 1000 hours (with Al-fin)</td>
</tr>
<tr>
<td>Low Temperature Storage Test</td>
<td>Ta=−40°C, 1000 hours</td>
</tr>
<tr>
<td>High Temperature Storage Test</td>
<td>Ta=100°C, 1000 hours</td>
</tr>
<tr>
<td>Moisture-proof Test</td>
<td>Ta=60°C, 90%RH, 1000 hours</td>
</tr>
<tr>
<td>Thermal Shock Test</td>
<td>Ta=−40°C 30 minutes~100°C 30 minutes, 100 cycle</td>
</tr>
</tbody>
</table>

(2) Judgment Criteria of Failure for Reliability Test  \( Ta=25°C \)

<table>
<thead>
<tr>
<th>Measuring Item</th>
<th>Symbol</th>
<th>Measuring Condition</th>
<th>Judgment Criteria for Failure</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward Voltage</td>
<td>( V_F )</td>
<td>( I_F=50) mA</td>
<td>&gt; U×1.2</td>
</tr>
<tr>
<td>Luminous Flux</td>
<td>( \Phi )</td>
<td>( I_F=50) mA</td>
<td>&lt; S×0.7</td>
</tr>
</tbody>
</table>

\( U \) defines the upper limit of the specified characteristics. \( S \) defines the initial value.

Note: Measurement shall be taken between 2 hours and 24 hours, and the test pieces should be return to the normal ambient conditions after the completion of each test.
7. Taping Specifications (in accordance with JIS standard)

(1) Shape and Dimensions of Reel

<table>
<thead>
<tr>
<th>Symbol</th>
<th>CITILED</th>
</tr>
</thead>
<tbody>
<tr>
<td>Name</td>
<td>CLL130-0101A5-30AM1B1</td>
</tr>
<tr>
<td>CITIZEN ELECTRONICS CO.,LTD. JAPAN</td>
<td></td>
</tr>
</tbody>
</table>

(2) Dimensions of Tape

![Diagram of tape dimensions]

<table>
<thead>
<tr>
<th>Symbol</th>
<th>CITILED</th>
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<tbody>
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<td></td>
</tr>
</tbody>
</table>

(3) Configuration of Tape

![Diagram of tape configuration]

(4) Quantity: 2500pcs/reel

Mounted with CITILED

Leading part more than 400mm

more than 40mm

Unloaded tape

Progressive direction

Ref.CE-P2157 09/12
8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant.

8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

Temperature : 5~30°C
Humidity : 60%RH max.

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again. Moisture Sensitive Level 1. (IPC/JEDEC J-STD-020C)
9. Precautions

9-1. Soldering

(1) Lead free soldering

1) Following soldering paste is recommended
   Melting temperature : 216 ~ 220°C.
   Composition : Sn 3.5Ag 0.75Cu

2) The temperature profile at the top surface of the parts is recommended as shown below.

3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature.

9-2. Washing

(1) When washing after soldering is needed, following conditions are requested.
   a) Washing solvent: Pure Water
   b) Temperature, time: 50°C or less × 30 seconds max or 30°C or less × 3 minutes max.
9-3. Eye Safety

- The International Electrical Commission (IEC) published in 2006 IEC 62471 “2006 Photobiological safety of lamps and lamp systems” which includes LEDs within its scope. When sorting single LEDs according to IEC 62471, most LEDs can be classified as belonging to either Exempt Group or Risk Group 1.

- Optical characteristics of LEDs such as radiant flux, spectrum and light distribution are factors that affect the risk group determination of the LED, and especially a high-power LED, that emits light containing blue wavelengths, may have properties equivalent to those of Risk Group 2.

- Great care should be taken when directly viewing an LED that is driven at high current, has multiple uses as a module or when focusing the light with optical instruments, as these actions may greatly increase the hazard to your eyes.

- In addition, LED sources that were included within the scope of IEC 60825-1 / Edition 1.2 “laser safety standard”, published 2001 were removed from the scope of the IEC 60825-1 / Edition 2.0 revised 2007.

- However, keep in mind that some countries and regions have adopted standards based on the IEC laser safety standard IEC 60825-1:2001 which includes LEDs within its scope.

9-4. Other directions

(1) It is requested to avoid any stress added to the resin portion while it is heated.

(2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

(3) If the product might to be used under the following conditions, the customer must evaluate its appropriateness them. This product is not designed for use under the following conditions. in places where the product might:
   - get wet due to rain
   - suffer from damage caused by salt.
   - be exposed to corrosive gas such as Cl, H₂S, NH₃, SO₂, NOₓ and so on.
   - be exposed to dust, fluid or oil.
10. Designing precautions

1. The current limiting resistor should be placed in the circuit so that it is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.

2. When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.

3. Recommended soldering pattern

   < For reflow soldering >

   Anode Pad

   Outline

   Center

   Cathode Pad

   Unit : mm

Mountability and solderability need to be optimized with actual conditions such as amount of solder, reflow temperature applied in the process.

4. When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.

5. When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.

6. Other
   This product complies with RoHS directives.

Symbol | CITILED
Name    | CLL130-0101A5-30AM1B1

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Ref.CE-P2157 09/12
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